HALOGEN

**FREE** 



# Vishay Semiconductors

# **Schottky Rectifier Surface Mount**



#### **MECHANICAL DATA**

Case: DO-219AB (SMF)

Polarity: color band denotes cathode end

Weight: approx. 15 mg
Packaging codes / options:

18/10K per 13" reel (8 mm tape), 50K/box 08/3K per 7" reel (8 mm tape), 30K/box

Int. construction: single

#### **FEATURES**

- For surface mounted applications
- · Low-profile package
- Ideal for automated placement
- Low power loss, high efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Meets JESD 201 class 2 whisker test
- Wave and reflow solderable
- AEC-Q101 qualified available
- Base P/N-E3 halogen-free, RoHS-compliant
- Base P/N-HE3 halogen-free, RoHS-compliant, and AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

PARTS TABLE				
PART	ORDERING CODE	MARKING	REMARKS	
SL04	SL04-E3-18 or SL04-E3-08 SL04-HE3-18 or SL04-HE3-08	S4	Tape and reel	

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Maximum repetitive peak reverse voltage		$V_{RRM}$	40	V	
Maximum average forward rectified current (fig. 4)		I <sub>F(AV)</sub>	1.1	Α	
Peak forward surge current 8.3 ms single half sine-wave $T_{J(init)} = 25  ^{\circ}\text{C}$		I <sub>FSM</sub>	40	Α	

THERMAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Thermal resistance junction to lead		R <sub>thJL</sub>	22	K/W
Thermal resistance junction to ambient air (1)		R <sub>thJA</sub>	180	K/W
Junction temperature in DC forward current without reverse bias		Tj	175	°C
Storage temperature range		T <sub>stg</sub>	-55 to +175	°C

#### Note

<sup>(1)</sup> Mounted on epoxy substrate with 3 mm x 3 mm Cu pads (≥ 40 µm thick)



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CON	IDITIONS	SYMBOL	TYP.	MAX.	UNIT
	I <sub>F</sub> = 0.5 A	T <sub>J</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.41	0.47	V
	I <sub>F</sub> = 1.1 A			0.48	0.54	
Instantaneous forward voltage	I <sub>F</sub> = 0.5 A	T <sub>J</sub> = 100 °C		0.34	-	
instantaneous forward voltage	I <sub>F</sub> = 1.1 A			0.43	-	
	I <sub>F</sub> = 0.5 A	T <sub>J</sub> = 125 °C		0.31	-	
	I <sub>F</sub> = 1.1 A			0.42	-	
		T <sub>J</sub> = 25 °C		10	20	μΑ
Reverse current	$V_{R} = 40 \text{ V}$	T <sub>J</sub> = 100 °C	$I_R$	1.2	2.6	mA
		T <sub>J</sub> = 125 °C		4.5	13	mA
Typical junction capacitance	V <sub>R</sub> = 4.0 V, 1 M	Hz	$C_D$	65	-	pF

#### Note

### RATINGS AND CHARACTERISTICS CURVES (T<sub>amb</sub> = 25 °C, unless otherwise specified)

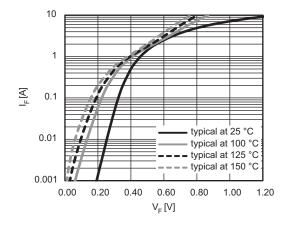


Fig. 1 - Typical Forward Characteristics

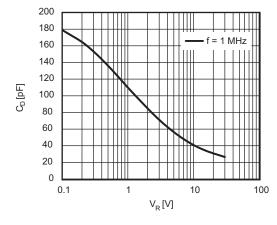


Fig. 2 - Typical Diode Capacitance vs. Reverse Voltage

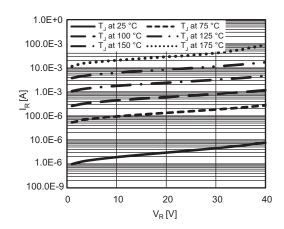


Fig. 3 - Typical Reverse Characteristics

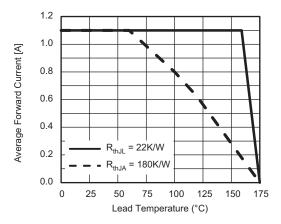


Fig. 4 - Forward Current Derating Curve

<sup>(1)</sup> Pulse test: 300 µs pulse width, 1 % duty cycle



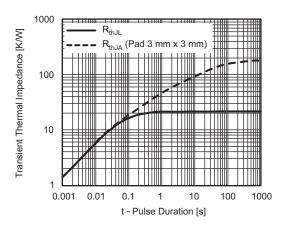
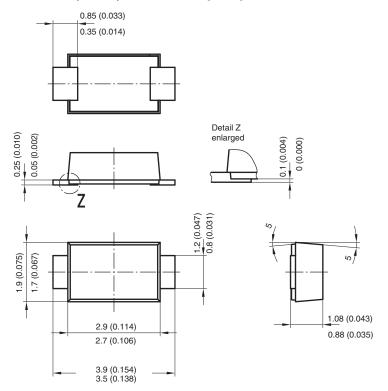
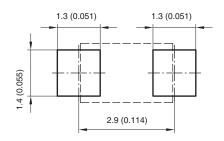


Fig. 5 - Typical Transient Thermal Impedance

### PACKAGE DIMENSIONS in millimeters (inches): DO-219AB (SMF)



Foot print recommendation:



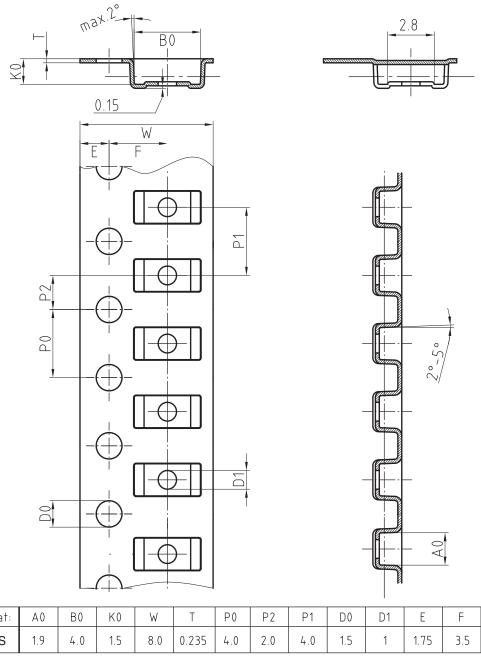
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### **BLISTERTAPE DIMENSIONS** in millimeters: **DO-219 AB (SMF)**



Mat: PS

Document-No.: S8-V-3717.02-001 (3)

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